

LNP093014S

Panel Display Units

White Type

■ Structure

- Illumination color: White
- Display surface: 192 mm × 96 mm
- Number of dots (dot): 1 152 (48 × 24 dot)
- Dot size: 1.60 mm × 0.80 mm
- Dot pitch: 4.0 mm

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Operating supply voltage	V_{CC}	-0.3 to +5.25	V
LED operating supply voltage	V_{LEDA}	+5.2	V
Input voltage	V_{IN}	-0.3 to $V_{CC} + 0.3$	V
Operating ambient temperature	T_{opr}	-10 to +45	$^\circ\text{C}$
Storage temperature	T_{stg}	-25 to +80	$^\circ\text{C}$

■ Recommending Operating Conditions $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

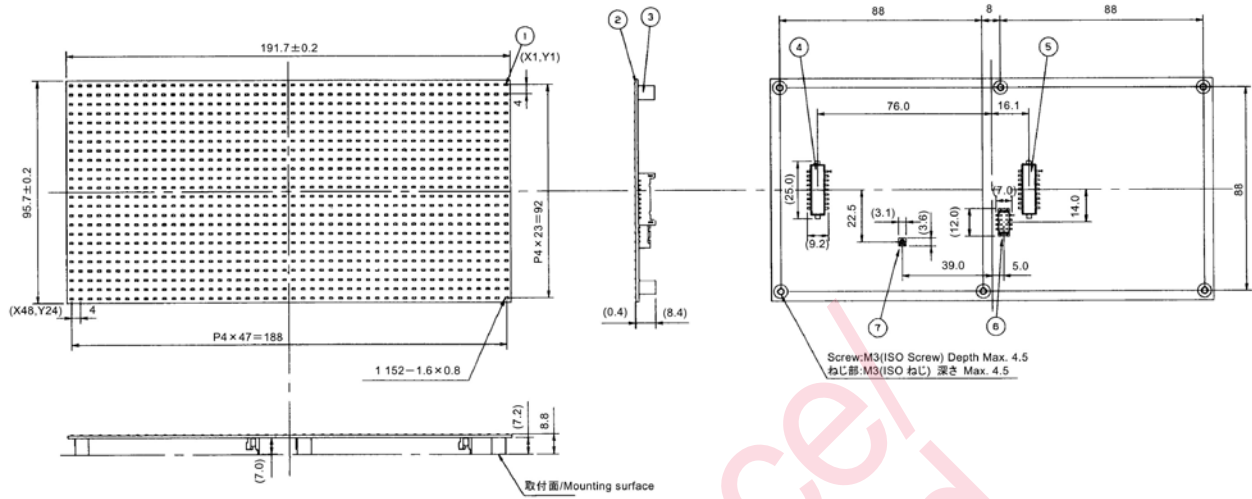
Parameter	Symbol	Min	Typ	Max	Unit
Operating supply voltage	V_{CC}	4.75	5.0	5.25	V
LED operating supply voltage	V_{LEDA}	4.80	5.0	5.20	V
Input voltage	V_{IN}	0.00	—	V_{CC}	V

■ Electro-Optical Characteristics $T_a = 25^\circ\text{C}$, $V_{CC} = V_{LEDA} = 5.0\text{ V}$

Parameter	Symbol	Specification		Unit
Brightness	—	White	Typ. 1600	cd/m^2
Dot brightness dispersion	—	≤ 2.5 times		—
Modulated light	—	8 stage		—
Viewing angle	$2\theta_{1/2}$	Horizontal direction	± 85	$^\circ$
		Vertical direction	Upper side: 85, Under side: 85	$^\circ$
Drive system	—	Duty 1/24 Dynamic lighting		—
Clock frequency	f_{CLK}	Max. 10		MHz
Supply current (Logic) *	$I_{CC(Logic)}$	Max. 0.3		A
Supply current (LED) *	$I_{CC(LED)}$	Max. 3.5		A

Note) *: Full-color lighting

■ Package (Unit: mm)



● Part name

1. LED
2. Printed board
3. Boss
4. Signal connector (input)
5. Signal connector (output)
6. Supply connector
7. Volume

Maintenance/Discontinued

Maintenance/Discontinued includes following four Product lifecycle stage.
(planned maintenance type, maintenance type, planned discontinued type, discontinued type)

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